

5645169-4  ACTIVE

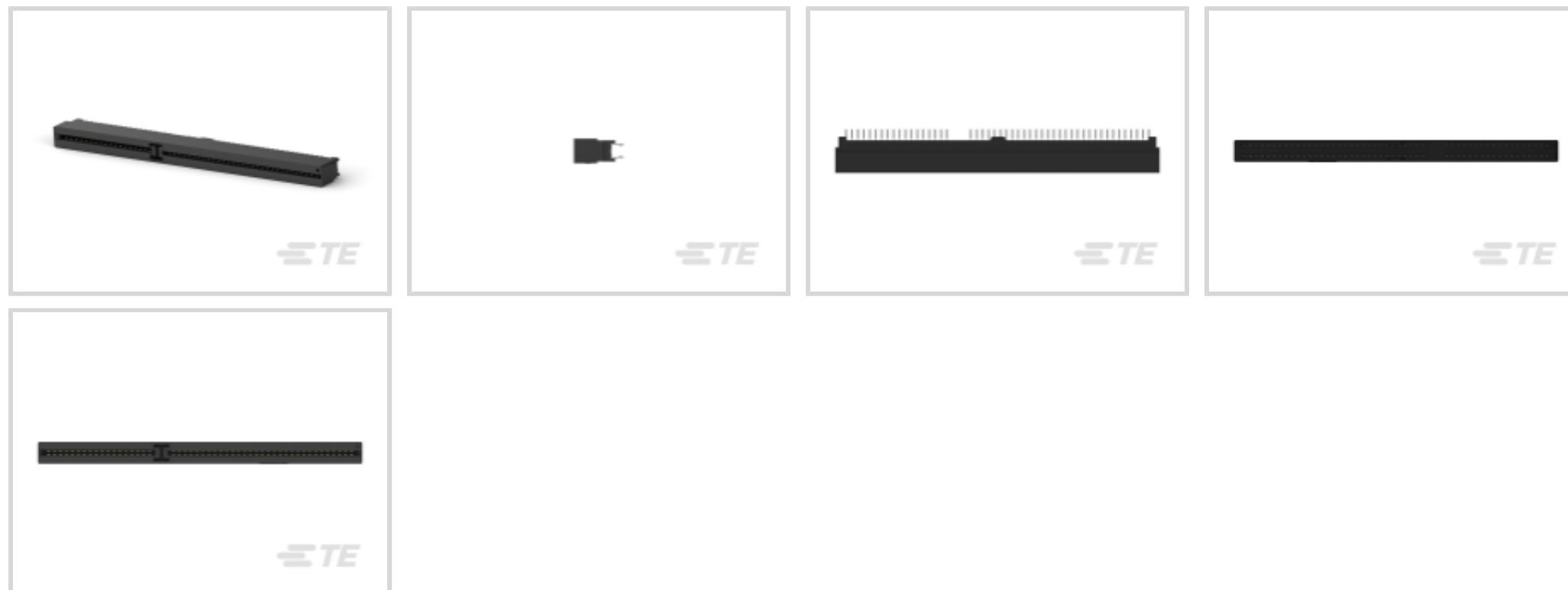
TE Internal #: 5645169-4

Board-to-Board, 98 Position, 2.54 mm [.1 in] Centerline, Power & Signal, 98 Power Positions, 0 Signal Positions, Card Edge Power Connectors

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Connectors > PCB Connectors > Card Edge Connectors > Card Edge Power Connectors



Connector System: **Board-to-Board**

Number of Positions: **98**

Centerline (Pitch): **2.54 mm [.1 in]**

Contact Current Rating (Max): **3 A**

Circuit Application: **Power & Signal**

## Features

### Product Type Features

Connector Mates With	Printed Circuit Board
Connector & Housing Type	Receptacle
Connector & Contact Terminates To	Printed Circuit Board
Connector System	Board-to-Board

### Configuration Features

Keying & Polarized Position Locations	0
Number of Sections	2
PCB Mount Orientation	Vertical
Number of Positions	98
Number of Power Positions	98
Number of Signal Positions	0
Number of Dual Positions	49

### Electrical Characteristics

Operating Voltage	400 V
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### Body Features

Primary Product Color	Black
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### Contact Features

PCB Contact Termination Area Plating Material Thickness	2.54 µm[100 µin]
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Contact Type	Socket
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Contact Mating Area Plating Material Thickness	.76 µm[30 µin]
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PCB Contact Termination Area Plating Material Finish	Matte
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Contact Underplating Material	Nickel
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PCB Contact Termination Area Plating Material	Tin
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Contact Base Material	Phosphor Bronze
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Contact Current Rating (Max)	3 A
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Contact Mating Area Plating Material	Gold
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### Termination Features

Termination Post & Tail Length	3.18 mm[.125 in]
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Termination Method to PCB	Through Hole - Solder
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### Mechanical Attachment

Mating Alignment Type	Keyed
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Mating Retention	Without
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Mating Alignment	With
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PCB Mount Alignment	Without
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PCB Mount Retention	With
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PCB Mount Retention Type	Solder Tail
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Connector Mounting Type	Board Mount
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### Housing Features

Housing Material	Polyester GF
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Centerline (Pitch)	2.54 mm[.1 in]
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### Dimensions

Card Slot Depth	7.49 mm[.295 in]
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Connector Height	15.49 mm[.61 in]
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Row-to-Row Spacing	4.85 mm[.241 in]
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Power Contact Centerline	2.54 mm[.1 in]
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### Usage Conditions

Operating Temperature Range

-55 – 85 °C[-67 – 185 °F]

**Operation/Application**

Circuit Application

Power &amp; Signal

**Industry Standards**

UL Flammability Rating

UL 94V-0

**Other**

Position Locations Omitted

0

**Product Compliance**For compliance documentation, visit the product page on [TE.com](http://TE.com)>

EU RoHS Directive 2011/65/EU

Compliant

EU ELV Directive 2000/53/EC

Compliant

China RoHS 2 Directive MIIT Order No 32, 2016

No Restricted Materials Above Threshold

EU REACH Regulation (EC) No. 1907/2006

Current ECHA Candidate List: JUNE 2024 (241)  
 Candidate List Declared Against: JUNE 2024 (241)  
 Does not contain REACH SVHC

Halogen Content

Not Low Halogen - contains Br or Cl &gt; 900 ppm.

Solder Process Capability

Wave solder capable to 265°C

## Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

**Compatible Parts**

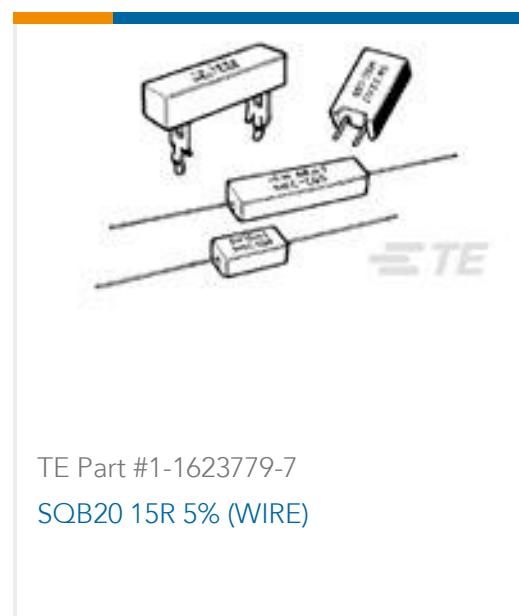


TE Part # 2343428-1  
HD+ CE, RA, CRPS

## Customers Also Bought



TE Part #3-917809-2  
DYNAMIC D-5 TAB HSG D/R 4P X-Y



TE Part #1-1623779-7  
SQB20 15R 5% (WIRE)



TE Part #5650118-3  
CONN SEC II 6 POS 100C/L R/A



TE Part #3-1827253-6  
.5FHP05H,220,S,GIG,08/Sn,HT,NSYes



TE Part #5145154-8  
STANDARD EDGE .050 SERIES 60  
DUAL ASSY



TE Part #1-406541-1  
MJ,INV,1X1,6PNL G,.100" ST,SN



TE Part #5-1625892-2  
3W SM M/OX 5% 470R



TE Part #1-338088-3  
8/8 INV.MOD.JACK



TE Part #9-1440003-0  
PCH-105D2H,000

## Documents

### Product Drawings

[CONN SEC II 49 POS 100C/L](#)

English

### CAD Files

[Customer View Model](#)

[ENG\\_CVM\\_CVM\\_5645169-4\\_B.2d\\_dxf.zip](#)

English

### 3D PDF

3D

**Customer View Model**[ENG\\_CVM\\_CVM\\_5645169-4\\_B.3d\\_jgs.zip](#)

English

**Customer View Model**[ENG\\_CVM\\_CVM\\_5645169-4\\_B.3d\\_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.**Product Specifications**[Application Specification](#)

English